N-Channel 100V, 118mΩ Typ. Power MOSFET

Description

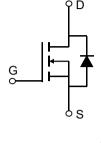
Features

• 100V, 3A

 $R_{DS(ON)}$ Typ = 118m Ω @ V_{GS} = 10V

 $R_{DS(ON)}$ Typ = 126m Ω @ V_{GS} = 4.5V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- 100% UIS TESTED!

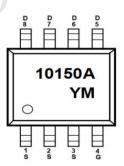




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMPTL10150A	10150A	SOP-8	TAPING	13"	4000	40000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _A = 25°C	3	А
I _D		T _A = 100°C	1.8	А
I _{DM}	Pulsed Drain Current (1)		12	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		12	mJ
P_{D}	Power Dissipation	T _A = 25°C	3	W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾		42	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
•	acteristics			J .		
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Char	acteristics				G	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.7	2.2	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	V _{GS} = 10V, I _D = 2A	-	118	153	mΩ
		V _{GS} = 4.5V, I _D = 1A	-	126	164	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-6	655	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	X-\	31	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11VII 12		24	-	pF
Q_g	Total Gate Charge		<u></u> -	14.8	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 3A$	_	3	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 30 V, I _D = 3A	-	4.4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	.()	-	12	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	7.6	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 3A$, $R_{GEN} = 3\Omega$	-	36	-	ns
t_f	Turn-Off Fall Time		-	9.2	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	3	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	12	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 3A$	_	_	1.2	V

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =7A

^{3.} R_{BJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{4.} Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

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Typical Performance Characteristics

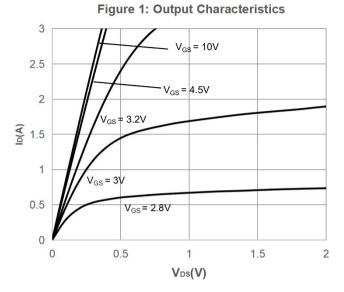


Figure 3: On-resistance vs. Drain Current

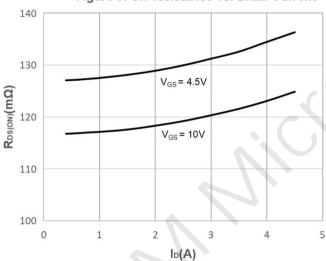


Figure 5: Gate Charge Characteristics

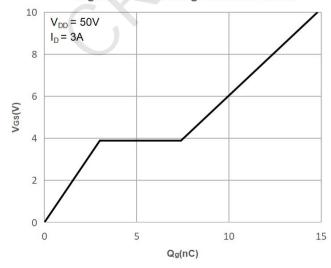


Figure 2: Typical Transfer Characteristics

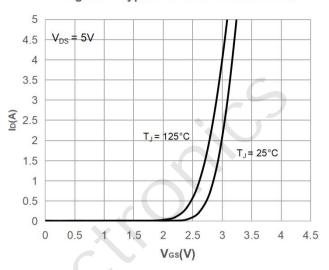


Figure 4: Body Diode Characteristics

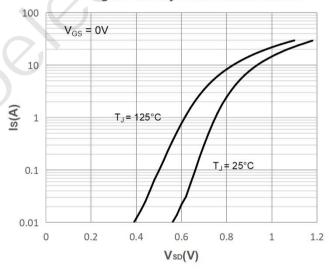
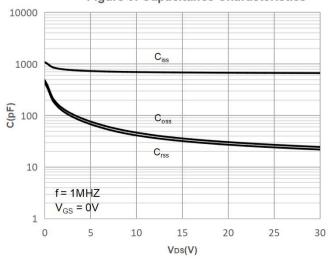


Figure 6: Capacitance Characteristics



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Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

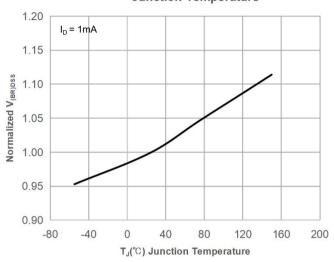


Figure 9: Maximum Safe Operating Area

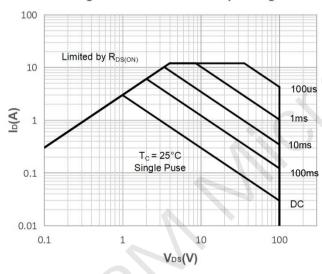


Figure 11: Normalized Maximum Transient

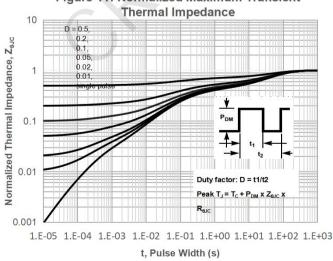


Figure 8: Normalized on Resistance vs. Junction Temperature

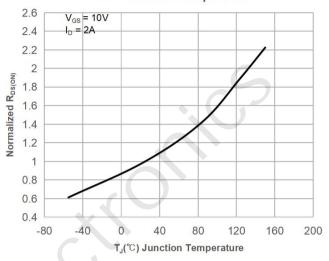


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

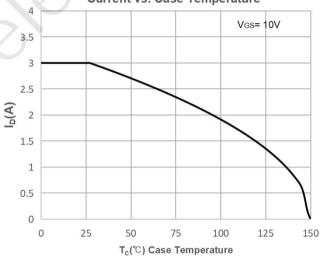
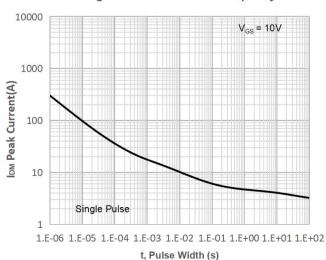


Figure 12: Peak Current Capacity



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Test Circuit

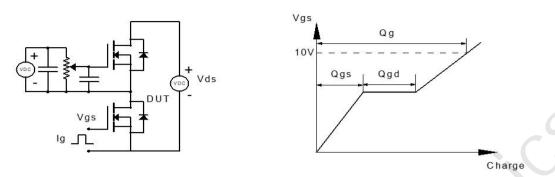


Figure 1: Gate Charge Test Circuit & Waveform

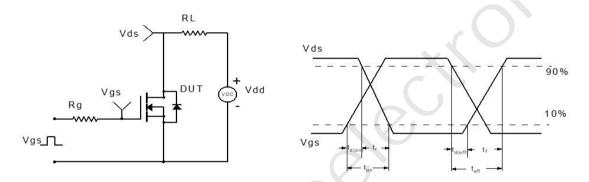


Figure 2: Resistive Switching Test Circuit & Waveform

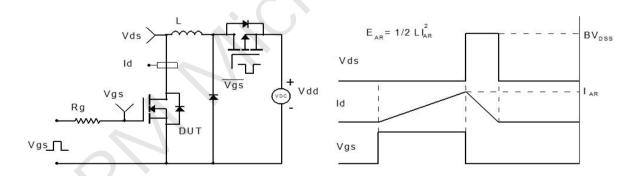


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

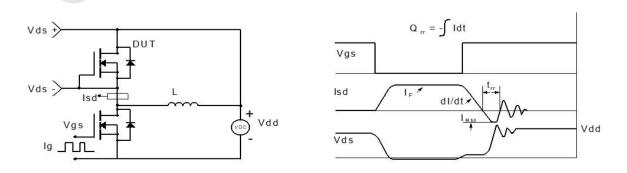
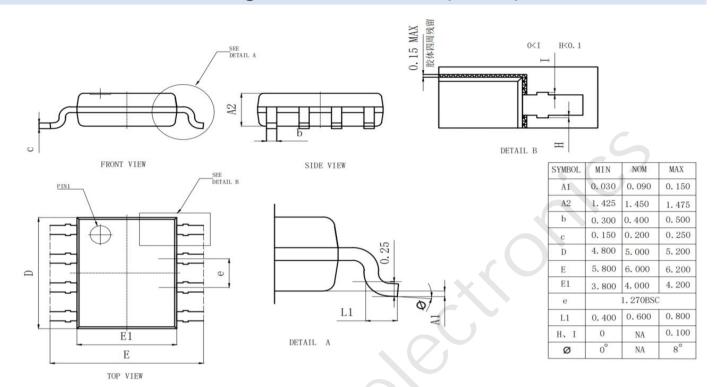


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(SOP-8)



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